

MSV Asia Scholarship

In 2022, MSV Systems & Services Pte Ltd made a gift of \$150,000 for the purpose of establishing an endowed scholarship for outstanding undergraduates of the College of Design and Engineering (CDE) who are specialising in semiconductor-related courses.

This bond-free undergraduate scholarship of up to S\$8,250 per annum (subject to the availability of the distributable return from the capital sum) is awarded to a deserving student for his/her normal course duration.

This scholarship is **by invitation only**. Shortlisted students will be invited to submit the necessary documentation and may be required to attend an interview.

Selection Criteria

The applicant should:

1. Be a Singapore citizen or a Singapore Permanent Resident.
2. Be a full-time CDE undergraduate in his/her first year of study (i.e., matriculation year).
3. Possess outstanding Singapore-Cambridge GCE A Level, local polytechnic diploma, International Baccalaureate diploma, NUS High School diploma or equivalent qualification. Participation in extra-curricular activities or community service will be considered favorably.
4. Not concurrently hold any other scholarship, fellowship, bursary, grant, award or allowance, without prior written approval from NUS.

While there is no bond attached to the MSV Asia Scholarship, students are required to take up the MOE Tuition Grant to receive the scholarship. Singapore Permanent Residents and international students who take up the MOE Tuition Grant will be bonded under the terms of the Tuition Grant - to work for a Singapore-registered company for three years immediately after graduation.

Scholarship recipient needs to complete at least 12 units of courses that are related to semiconductors over the normal course duration. In addition, the recipient needs to maintain a Grade Point Average (GPA) of 3.50 and above in each academic year to continue receiving the scholarship.